

Junqi Dai

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Education

School of Computer Science

MASTER IN COMPUTER SCIENCE

Advisor: Prof. Xipeng Qiu

Fudan University

Sept. 2019 - Jan. 2022 (Expected)

College of Foreign Languages and Literatures

B.A. IN KOREAN LANGUAGE AND LITERATURE

Outstanding Graduate

National Encouragement Scholarship, 2016, 2017

Fudan University

Sept. 2015 - Jun. 2019

Publications

Aspect-Based Sentiment Analysis

EXPLAINABOARD: An Explainable Leaderboard for NLP 🔗

PENGFEI LIU, JINLAN FU, YANG XIAO, WEIZHE YUAN, SHUAICHENG CHANG, **JUNQI DAI**, YIXIN LIU, ZIHUIWEN YE, GRAHAM NEUBIG

- **ACL 2021, Best Demo Paper**

A Unified Generative Framework for Aspect-based Sentiment Analysis 🔗

HANG YAN*, **JUNQI DAI***, TUO JI, XIPENG QIU, ZHENG ZHANG

- Equal Contribution
- **ACL 2021, Long paper, Oral Presentation**

Does syntax matter? A strong baseline for Aspect-based Sentiment Analysis with RoBERTa 🔗

JUNQI DAI*, HANG YAN*, TIANXIANG SUN, PENGFEI LIU, XIPENG QIU

- **NAACL 2021, Long paper**

Information Extraction

A Unified Generative Framework for Various NER Tasks 🔗

HANG YAN, TAO GUI, **JUNQI DAI**, QIPENG GUO, ZHENG ZHANG, XIPENG QIU

- **ACL 2021, Long paper**

Adapt BART Encoder and Decoder for Document-level Relation Extraction

HANG YAN*, **JUNQI DAI***, YU SUN, XIANGKUN HU, QIPENG GUO, YUNHUA ZHOU, XIPENG QIU, ZHENG ZHANG

- Equal Contribution
- **EMNLP 2021 Submission**

Efficient Encoder-Decoder based Machine Reading Comprehension Formulation for Event Extraction

HANG YAN*, **JUNQI DAI***, YU SUN, XIANGKUN HU, QIPENG GUO, YUNHUA ZHOU, XIPENG QIU, ZHENG ZHANG

- Equal Contribution
- **EMNLP 2021 Submission**

Semantic Parsing

Semantic Meaning Representation for Dialogue

JUNQI DAI, XIANGKUN HU, HANG YAN, QIPENG GUO, XIPENG QIU, ZHENG ZHANG

- **AAAI 2022 Submission**

Research Experience

Applied Scientist Intern

ML SOLUTIONS LAB

- Advisor: Prof. Zheng Zhang, Xiangkun Hu
- Working on semantic parsing for dialogue system (AAAI submission)

Amazon, Shanghai

Jun. 2021 - Present